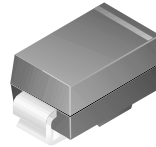


# ES1A - ES1D

## Features

- For surface mount applications.
- Glass passivated junction.
- Low profile package.
- Easy pick and place.
- Built-in strain relief.
- Superfast recovery times for high efficiency.



**SMA/DO-214AC**  
COLOR BAND DENOTES CATHODE

## Fast Rectifiers

### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value				Units
		1A	1B	1C	1D	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	150	200	V
$I_{F(AV)}$	Average Rectified Forward Current, @ $T_A=120^\circ\text{C}$	1.0				A
$I_{FSM}$	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30				A
$T_{stg}$	Storage Temperature Range	-50 to +150				$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-50 to +150				$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### Thermal Characteristics

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	1.47	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	85	$^\circ\text{C}/\text{W}$
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	35	$^\circ\text{C}/\text{W}$

\*Device mounted on FR-4 PCB 0.013 mm.

### Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Device				Units
		1A	1B	1C	1D	
$V_F$	Forward Voltage @ 1.0 A	0.92				V
$t_{rr}$	Reverse Recovery Time $I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{RR} = 0.25\text{ A}$	15				ns
$I_R$	Reverse Current @ rated $V_R$ $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	5.0 100				$\mu\text{A}$ $\mu\text{A}$
$C_T$	Total Capacitance $V_R = 4.0\text{ V}, f = 1.0\text{ MHz}$	7.0				pF

## Typical Characteristics

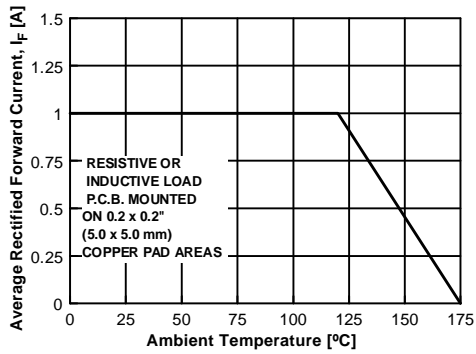


Figure 1. Forward Current Derating Curve

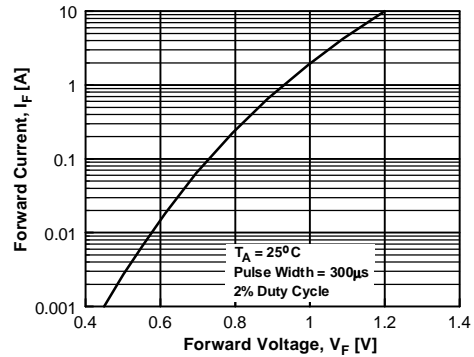


Figure 2. Forward Voltage Characteristics

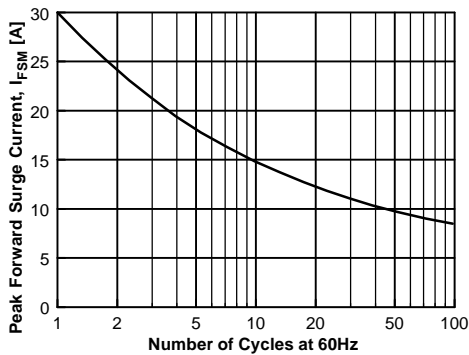


Figure 3. Non-Repetitive Surge Current

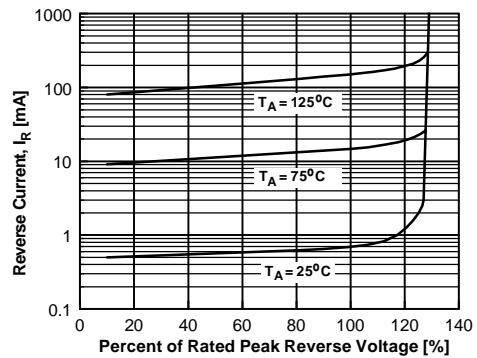


Figure 4. Reverse Current vs Reverse Voltage

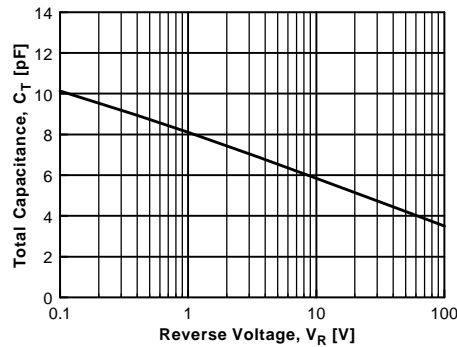
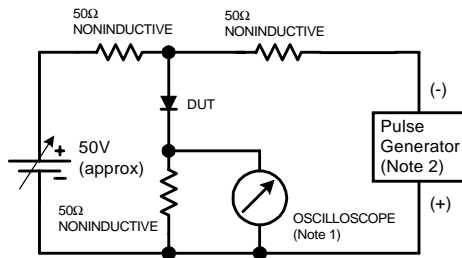
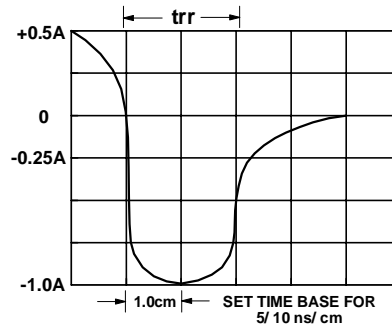


Figure 5. Total Capacitance



NOTES:

1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.
2. Rise time = 10 ns max; Source impedance = 50 ohms.



### Reverse Recovery Time Characteristic and Test Circuit Diagram

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